To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

DATA SHEET

MOS FIELD EFFECT TRANSISTOR
2SK3326B

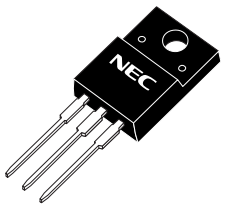
SWITCHING
N-CHANNEL POWER MOSFET

DESCRIPTION

The 2SK3326B is N-Channel MOSFET device that features a low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply, AC adapter.

FEATURES

(Isolated TO-220)



- Low gate charge
  Q_G = 20 nC TYP. (V_{DD} = 400 V, V_{GS} = 10 V, I_D = 10 A)
- Gate voltage rating : ±30 V
- Low on-state resistance
  $R_{DS(on)}$ = 0.85 Ω MAX. (V_{GS} = 10 V, I_D = 5.0 A)
- Avalanche capability ratings

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
2SK3326B-S17-AY Note	Pure Sn (Tin)	Tube 50 p/tube	Isolated TO-220 (MP-45F) typ. 2.2 g

Note Pb-free (This product does not contain Pb in external electrode.)

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	500	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	±30	V
Drain Current (DC) (T_C = 25°C)	$I_{D(DC)}$	±10	A
Drain Current (pulse) Note1	$I_{D(pulse)}$	±40	A
Total Power Dissipation (T_A = 25°C)	P_{T1}	2.0	W
Total Power Dissipation (T_C = 25°C)	P_{T2}	40	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C
Single Avalanche Current Note2	I_{AS}	10	A
Single Avalanche Energy Note2	E_{AS}	10.7	mJ

Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Starting T_{ch} = 25°C, V_{DD} = 150 V, R_G = 25 Ω, V_{GS} = 20 → 0 V

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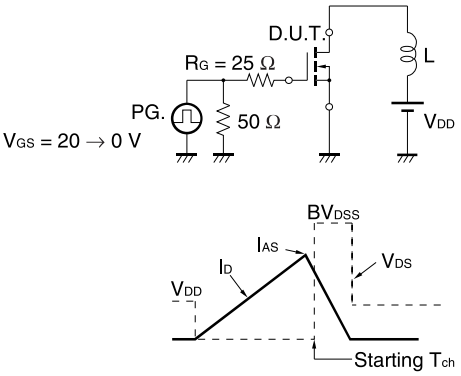
The mark <R> shows major revised points.
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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

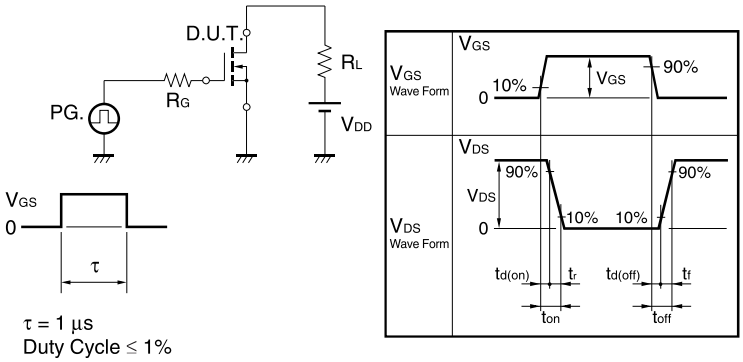
Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 500 V, V_{GS} = 0 V			100	μA
Gate Leakage Current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
Gate Cut-off Voltage	$V_{GS(off)}$	V_{DS} = 10 V, I_D = 1 mA	2.5		3.5	V
Forward Transfer Admittance **Note**	$\|y_{fs}\|$	V_{DS} = 10 V, I_D = 5.0 A	2.0	3.9		S
Drain to Source On-state Resistance **Note**	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 5.0 A		0.76	0.85	Ω
Input Capacitance	C_{iss}	V_{DS} = 10 V		1270		pF
Output Capacitance	C_{oss}	V_{GS} = 0 V		210		pF
Reverse Transfer Capacitance	C_{rss}	f = 1 MHz		6		pF
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 150 V, I_D = 5.0 A		19		ns
Rise Time	t_r	V_{GS} = 10 V		6.5		ns
Turn-off Delay Time	$t_{d(off)}$	R_G = 10 Ω		31		ns
Fall Time	t_f	R_L = 60 Ω		5		ns
Total Gate Charge	Q_G	V_{DD} = 400 V		20		nC
Gate to Source Charge	Q_{GS}	V_{GS} = 10 V		9.5		nC
Gate to Drain Charge	Q_{GD}	I_D = 10 A		5.5		nC
Body Diode Forward Voltage **Note**	$V_{F(S-D)}$	I_F = 10 A, V_{GS} = 0 V		0.98	1.5	V
Reverse Recovery Time	t_{rr}	I_F = 10 A, V_{GS} = 0 V		440		ns
Reverse Recovery Charge	Q_{rr}	di/dt = 50 A/μs		2000		nC

Note Pulsed

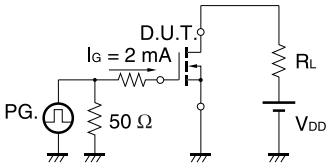
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

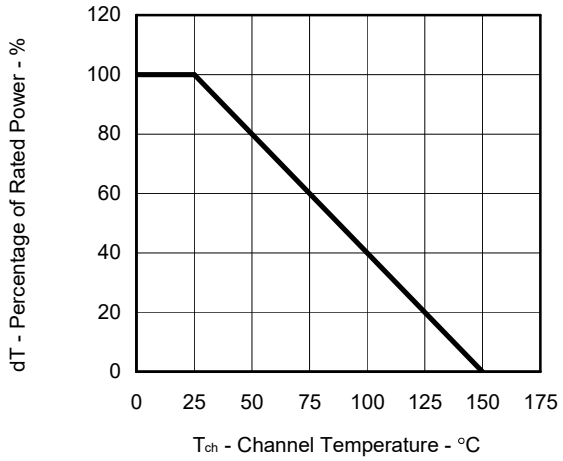


TEST CIRCUIT 3 GATE CHARGE

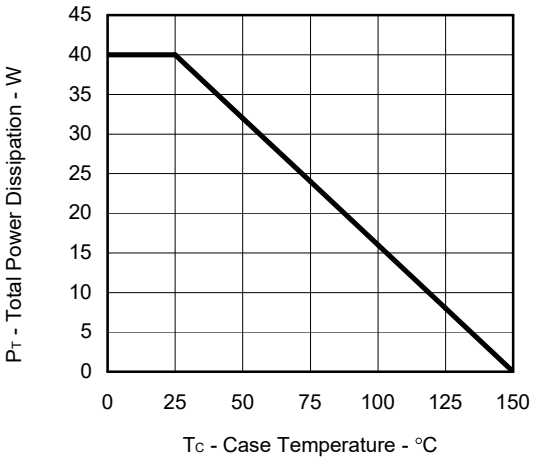


TYPICAL CHARACTERISTICS (T_A = 25°C)

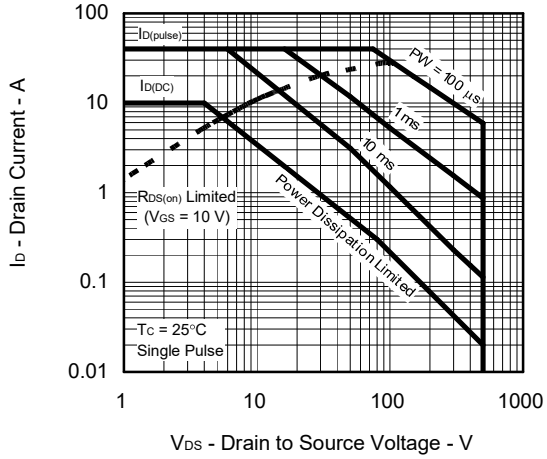
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



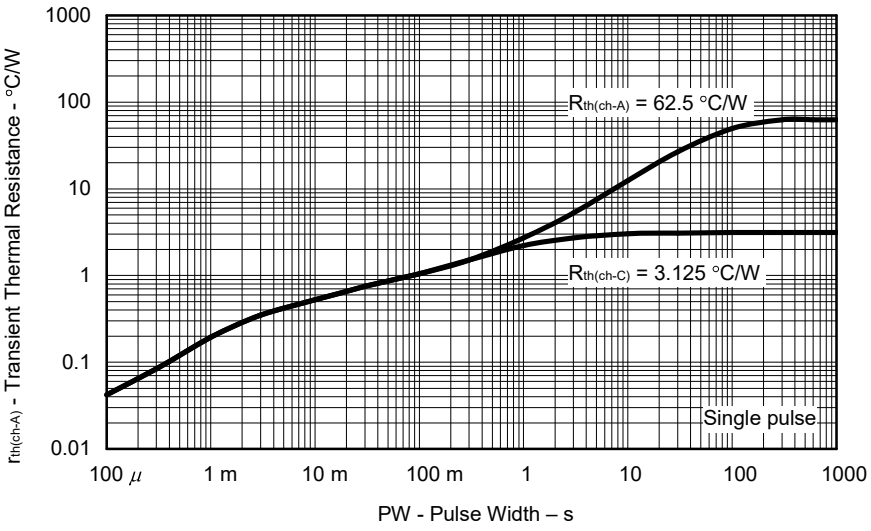
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



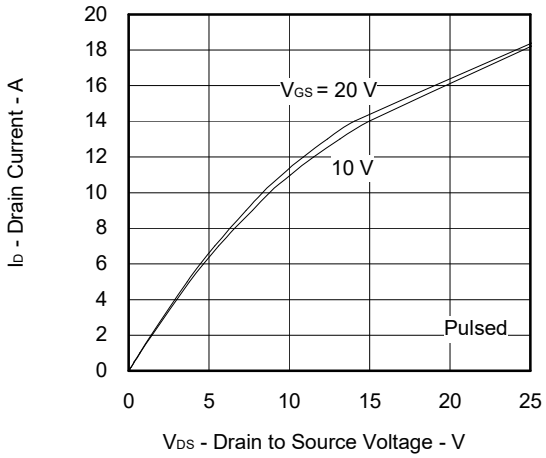
FORWARD BIAS SAFE OPERATING AREA



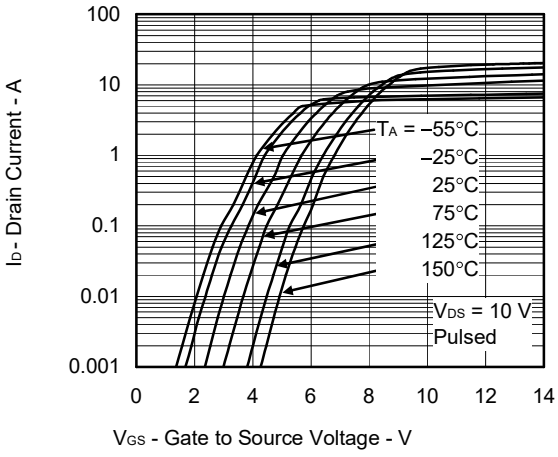
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



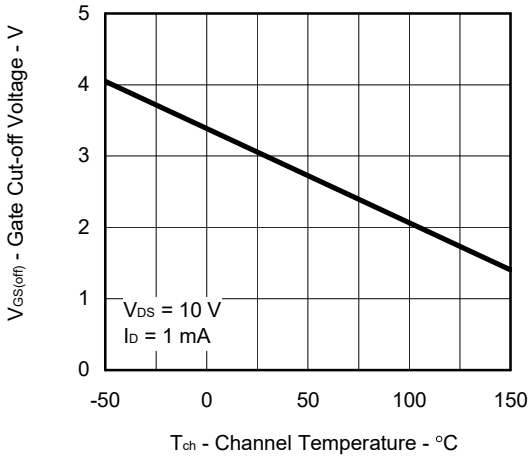
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



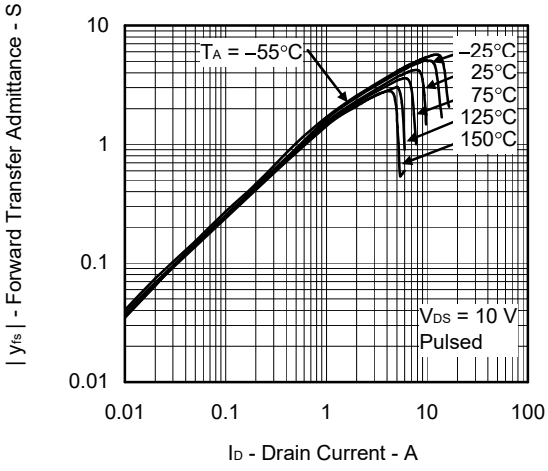
FORWARD TRANSFER CHARACTERISTICS



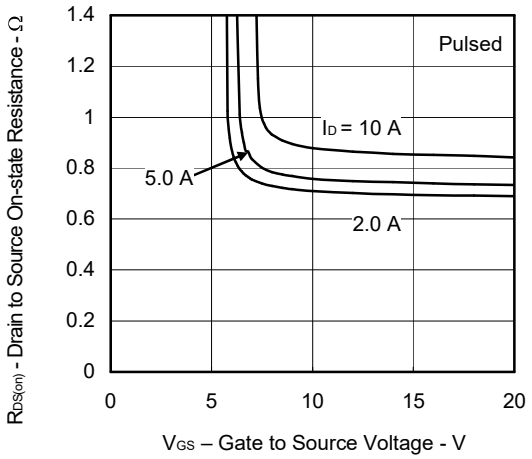
GATE CUT-OFF VOLTAGE vs.
CHANNEL TEMPERATURE



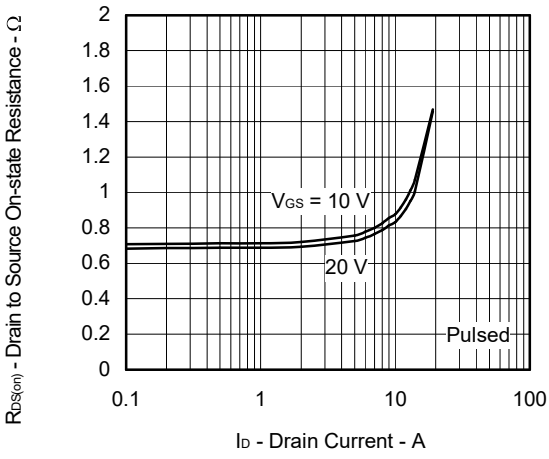
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENT



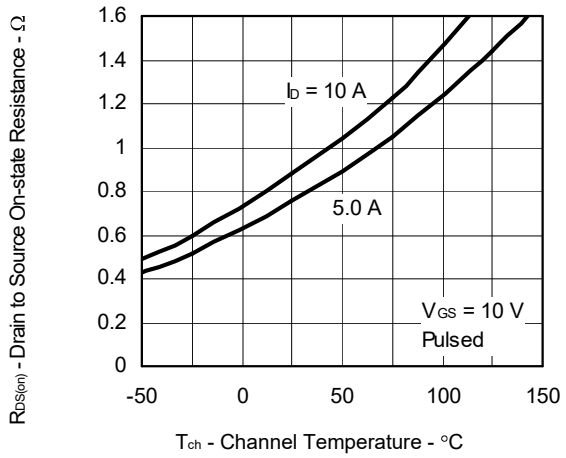
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



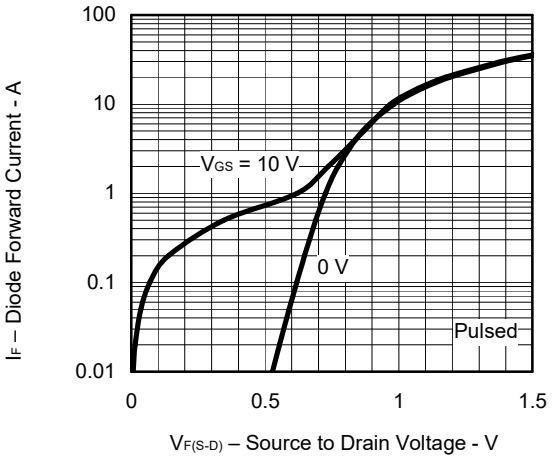
DRAIN TO SOURCE ON-STATE
RESISTANCE vs. DRAIN CURRENT



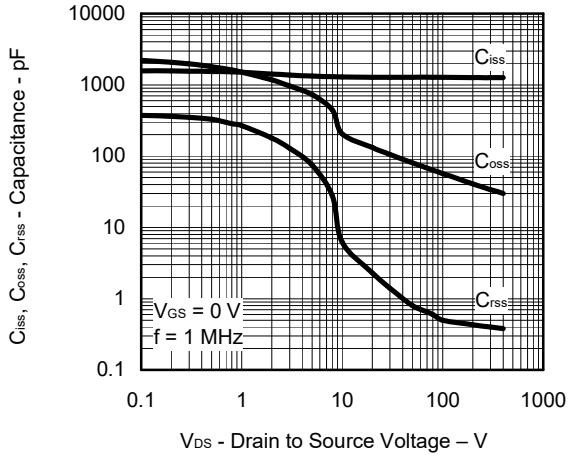
<R> DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



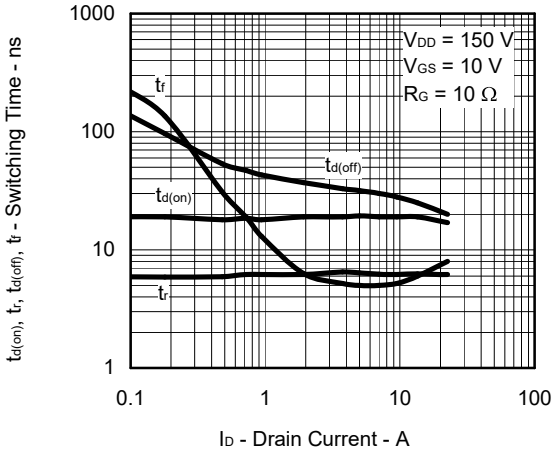
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



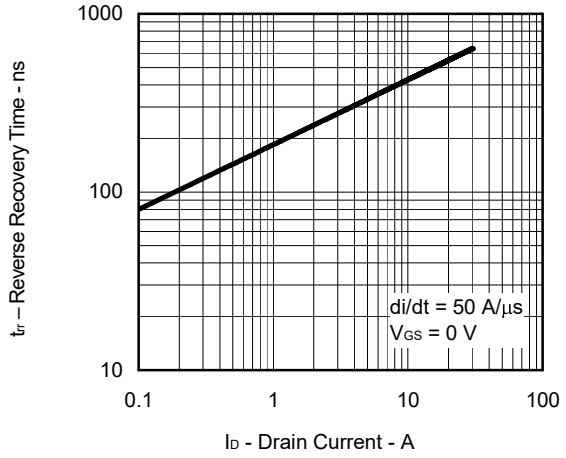
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



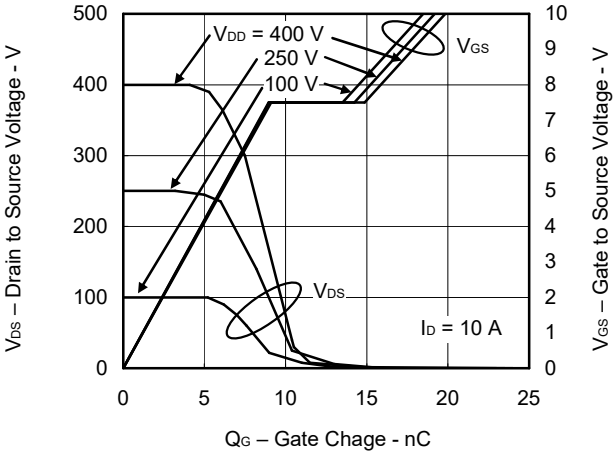
SWITCHING CHARACTERISTICS



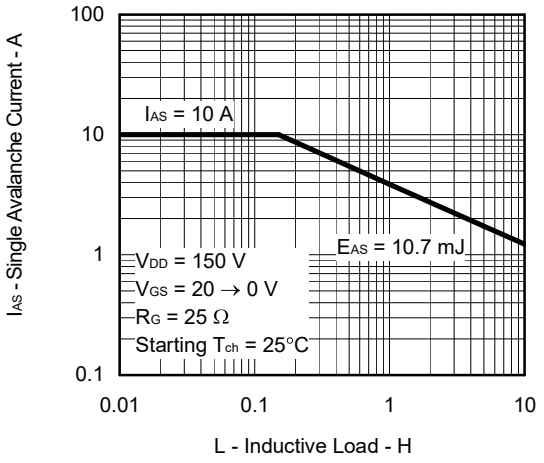
REVWESE RECOVERY TIME vs. DRAIN CURRENT



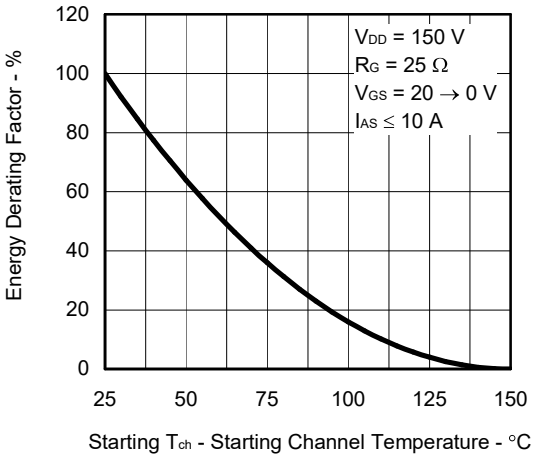
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SINGLE AVALANCHE CURRENT vs.
INDUCTIVE LOAD

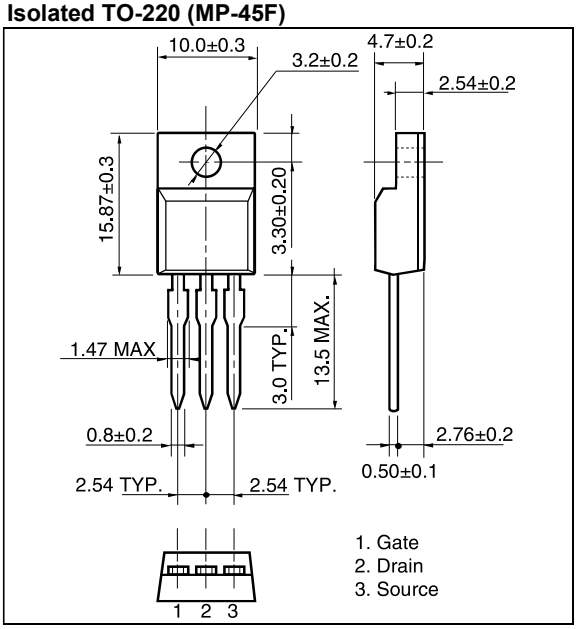


SINGLE AVALANCHE ENERGY
DERATING FACTOR

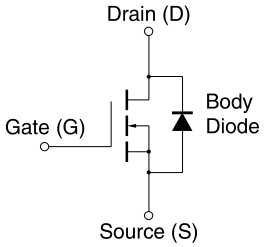


PACKAGE DRAWING (Unit: mm)

Isolated TO-220 (MP-45F)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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